



Features

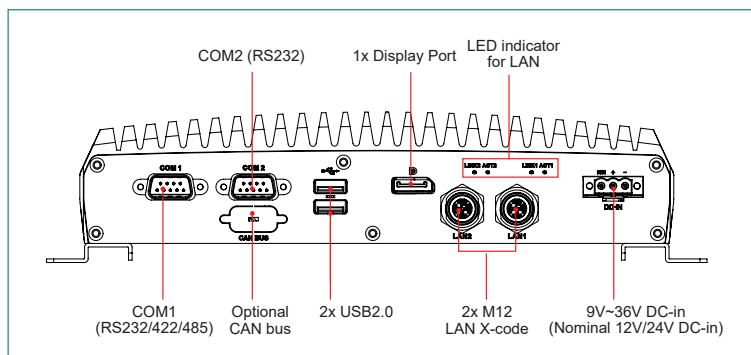
- Intel® Atom® x7000RE Series Processor
- Robust M12 & FAKRA connectors with rich I/O interface
- Dual SIM sockets support WWAN redundancy
- Rich I/O interfaces for wireless, SSD, GPS, WWAN and add-on card expansion
- Wide range DC input with ignition power control
- E-Fuse power protection and supercapacitor-based battery design
- Wide-range operating temperature from -40°C to 70°C
- Built in Hailo-8 AI accelerator chip (MPT-3100V-AI)
- Optional isolated CANbus thru Mini PCI-E card
- Removable 2.5" device bay for SSD storage

Specifications

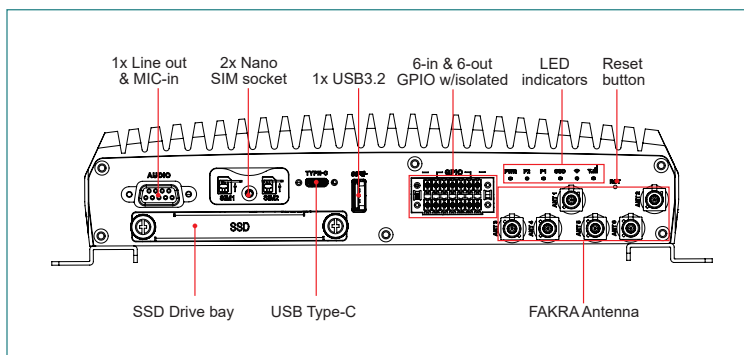
System Mainboard	MBT-3101
CPU Type	Intel® Atom® x7433RE Processor
Processor Speed	Up to 2.7GHz
Memory	1x DDR5-4800 SO-DIMM socket Up to 16GB
Front Panel External I/O	1x USB 3.2 Gen2 stack Type-A connector 2x external accessible SIM socket 1x USB Type-C connector with screw-lock 1x Removable 2.5" SSD device bay 1x DB9 female connector for Line-out & MIC-in 1x reset button 1x 14-pin terminal block 6-in & 6-out digital I/O with 24V input and output 6x FAKRA antenna holes 4x light-pipe for status LED Indicators
Rear Panel External I/O	2x M12 X-code 8P female for GbE LAN1/LAN2 1x terminal block 3-pin for DC-input 1x VGA connector for graphic output (optional) 1x DisplayPort output 1x DB9F connector for 2x CAN FD bus connection (works with extra CAN module) 2x DB9M for COM#1 / COM#2 2x USB 2.0 Type-A connector 2x light-pipe for LAN status LED Indicators
Storage	1x M.2 2280 M-Key socket for SSD (SATA III signal) 1x 2.5" removable device bay for SSD

Expansion slots	1x M.2 2230 E-Key socket for WLAN & BT connection (PCI-E + USB 2.0 + SMBus) 1x M.2 3042/52 B-Key socket for WWAN (4G/5G) connection (USB3 .2 Gen.1 + SMBus) 1x M.2 2280 M-Key socket for SSD device (SATA III) 1x Mini PCI-E full-sized socket for MVB/CAN FD module (PCI-E + USB 2.0 + SMBus) 1x Mini-PCIe half-size socket for GPS module (USB2.0 only)
Power Supply	DC-input 9V ~ 36V (Nominal DC-input 12V/24V)
Construction	Aluminum
Chassis Color	Black
Mounting	wall mount
Dimensions	250 (W) x 150 (D) x 55 (H) mm 9.84" (W) x 5.9" (D) x 2.16" (H)
Operating Temperature	-40°C ~ 70°C (-40°F ~ 158°F) (w/o FAN & SSD) -20°C ~ 55°C (-4°F ~ 131°F) (w/ PCI-E card)
Storage Temperature	-40°C ~ 85°C (-40°F ~ 185°F)
Relative Humidity	10 ~ 95% RH @45°C (non-condensing)
Vibration	Operating/Non-operating (SSD): 2.26 Grms (5~500 Hz) / MIL-STD-810G composite wheeled condition (Z-axis only)
Shock	Operating: Sawtooth: 20G, 11msec (Z-axis) / MIL-STD-810G Non-operating: Sawtooth: 40G, 11 msec (Z-axis) / MIL-STD-810G
Certified	ITxPT & E-Mark-24 CE (EN 62368-1 / EN55032 / EN55035), FCC Class-A

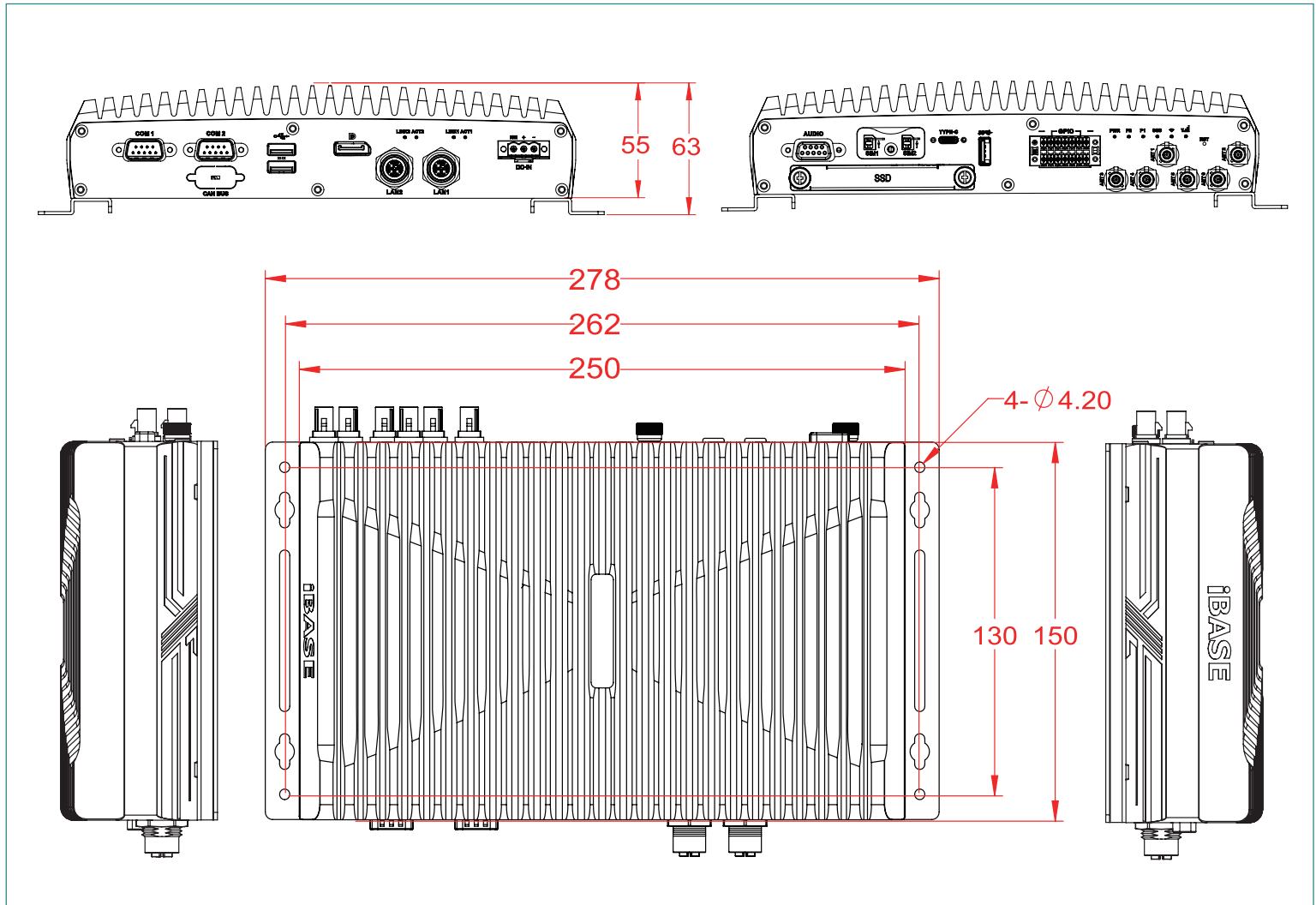
Rear External I/O



Front External I/O



Dimensions



Ordering Information

Part Number	Model Name	CPU	RAM	Storage	Display	LAN M12 X-Coded	USB	COM Ports	M.2 or Mini PCI-E	Power Input	Note
S02MPT3100-OB2300R	MPT-3100V	Atom® x7211RE	8GB	N/A	1x DP 1x USB-C	2	1x USB 3.2 2x USB 2.0	2	5	9V~36V	ITxPT version
S02MPT3100-OB2100R	MPT-3100V-X33RE	Atom® x7433RE									2x PoE(30W)
S02MPT3100-OB2200R	MPT-3100V-AI										2x PoE(30W) w/ Hailo AI accelerator

Packing List

Part Number	Description	Qty.
-	MPT-3100V	1
D2MANUAL--0000100P	Manual @ Driver download instruction	1
H06MTMPT3100V000AP	Wall mount bracket	2
C12165ESD03105200P	DC-in Matching Connector (3 pins)	1
C1216022107103000P	GPIO Matching Connector (7 pins)	2
H032GM15250010000P	Screw for SSD (if not pre-installed)	4
H0230561B710BN000P	Screw for wall mount	4

Optional Items

Part Number	Description
C501LAN8208A32000P	LAN cable: M12 X-Code to RJ45 CAT-6 (up to 2.5GbE)
C501LAN6300A32000P	LAN cable: M12 X-Code to RJ45 CAT-5 (up to 1.0GbE)
-	Audio cable: DB9F to 3.5mm Audio jack for Line-out & MIC-in
A008MINIPCI-E09000P	CAN Bus module (Mini PCIe card)
C501PK11920203000P	20CM CAN Bus internal cable